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Omron
G3VM-61B1

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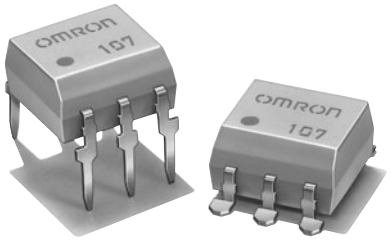
G3VM-61B1/E1

MOS FET Relays

Analog-switching MOS FET Relays for High Switching Currents, with Dielectric Strength of 2.5 kVAC between I/O.

- **Upgraded G3VM-61B/E Series.**
- **Switches minute analog signals.**
- **Leakage current of 1 μA max. when output relay is open.**

RoHS compliant

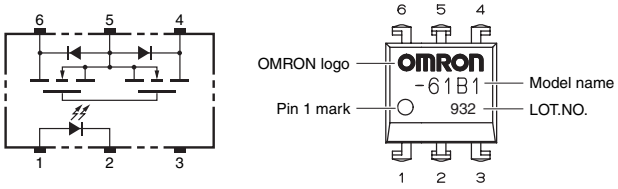


Note: The actual product is marked differently from the image shown here.

■ Application Examples

- **Test & Measurement equipment**
- **Security equipment**
- **Amusement equipment**

■ Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value) ✻	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
DIP6	1a (SPST-NO)	PCB Terminals	60 V	**G3VM-61B1**	50	-
		Surface-mounting Terminals		**G3VM-61E1**		
				G3VM-61E1 (TR)	-	1,500

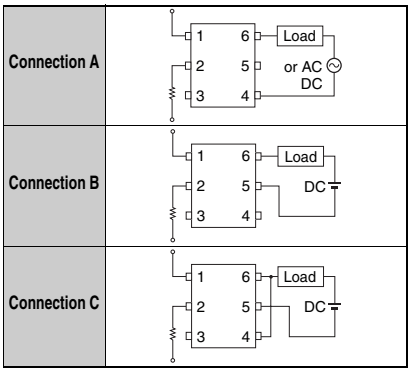
✻ The AC peak and DC value are given for the load voltage.

■ Absolute Maximum Ratings (Ta = 25°C)

Item			Symbol	Rating	Unit	Measurement conditions
Input	**LED forward current**		I_F	50	mA	
	Repetitive peak LED forward current		I_{FP}	1	A	100 μs pulses, 100 pps
	LED forward current reduction rate		ΔI_F/°C	−0.5	mA/°C	Ta ≥ 25°C
	LED reverse voltage		V_R	5	V	
	Connection temperature		T_J	125	°C	
Output	**Load voltage (AC peak/DC)**		V_{OFF}	60	V	
	Continuous load current	Connection A	I_O	500	mA	Connection A: AC peak/DC Connection B and C: DC
		Connection B		500		
		Connection C		1000		
	ON current reduction rate	Connection A	ΔI_O/°C	−5	mA/°C	Ta ≥ 25°C
		Connection B		−5		
		Connection C		−10		
	Connection temperature		T_J	125	°C	
Dielectric strength between I/O (See note 1.)			V_{I-O}	2500	Vrms	AC for 1 min
Ambient operating temperature			Ta	−40 to +85	°C	With no icing or condensation
Ambient storage temperature			Tstg	−55 to +125	°C	With no icing or condensation
Soldering temperature			-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

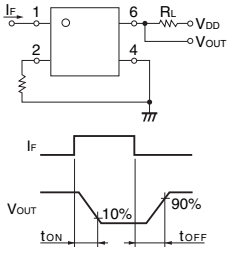
Connection Diagram



■ Electrical Characteristics (Ta = 25°C)

Item			Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	**LED forward voltage**		V_F	1.0	1.15	1.3	V	I_F = 10 mA
	Reverse current		I_R	-	-	10	μA	V_R = 5 V
	Capacity between terminals		C_T	-	30	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current		I_{FT}	-	1.6	3	mA	I_O = 500 mA
Output	**Maximum resistance with output ON**	Connection A	R_{ON}	-	1	2	Ω	I_F = 5 mA, I_O = 500 mA
		Connection B		-	0.5	1	Ω	I_F = 5 mA, I_O = 500 mA
		Connection C		-	0.25	-	Ω	I_F = 5 mA, I_O = 1000 mA
	Current leakage when the relay is open		I_{LEAK}	-	-	1.0	μA	V_{OFF} = 60 V
	Capacity between terminals		C_{OFF}	-	130	-	pF	V = 0, f = 1 MHz
Capacity between I/O terminals			C_{I-O}	-	0.8	-	pF	f = 1 MHz, V_S = 0 V
Insulation resistance between I/O terminals			R_{I-O}	1000	-	-	MΩ	V_{I-O} = 500 VDC, RoH ≤ 60%
Turn-ON time			t_{ON}	-	0.8	2.0	ms	I_F = 5 mA, R_L = 200 Ω,
Turn-OFF time			t_{OFF}	-	0.1	0.5	ms	V_{DD} = 20 V(See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



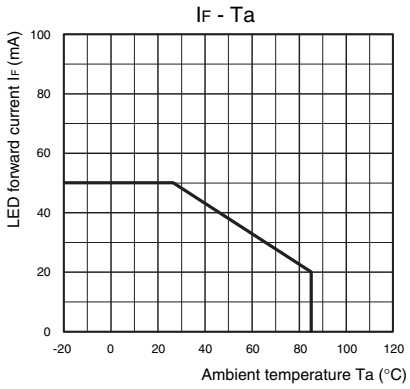
■ Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

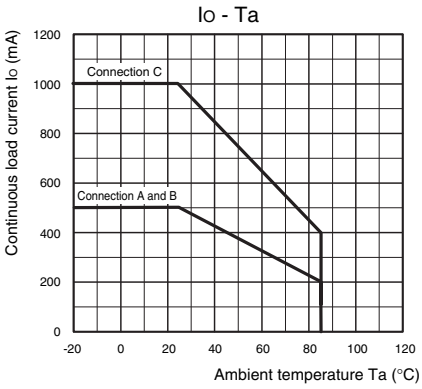
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	-	-	48	V
Operating LED forward current	I_F	5	7.5	25	mA
Continuous load current (AC peak/DC)	I_O	-	-	500	mA
Ambient operating temperature	Ta	–20	-	65	°C

■ Engineering Data

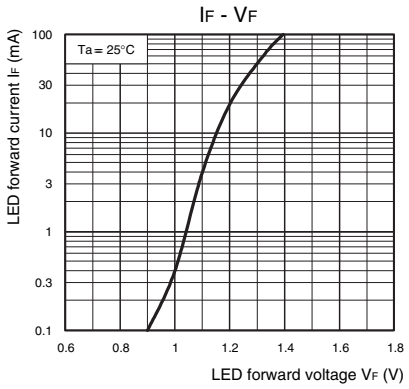
LED forward current vs. Ambient temperature



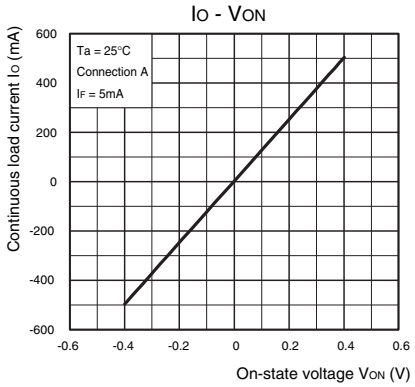
Continuous load current vs. Ambient temperature



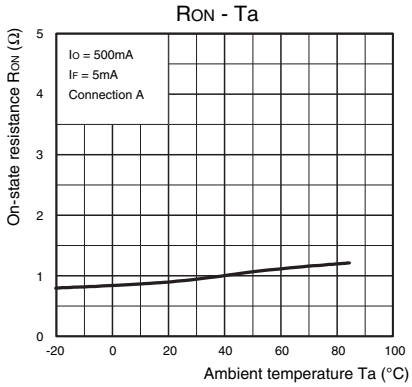
LED forward current vs. LED forward voltage



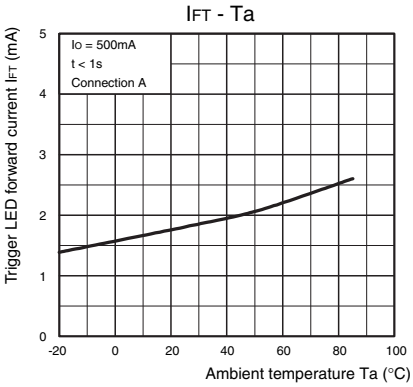
Continuous load current vs. On-state voltage



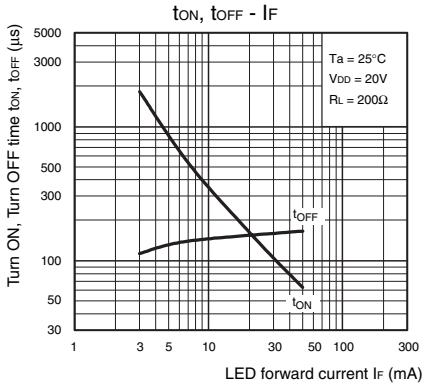
On-state resistance vs. Ambient temperature



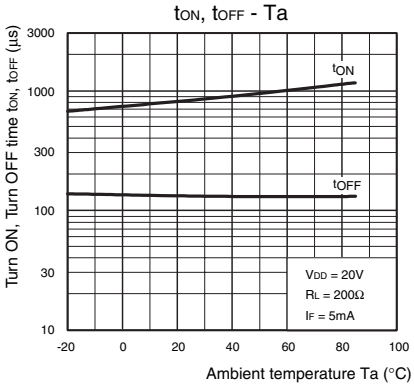
Trigger LED forward current vs. Ambient temperature



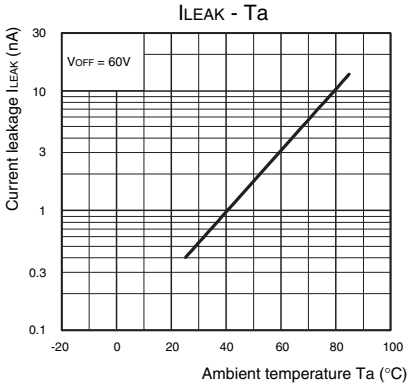
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature



■ Safety Precautions

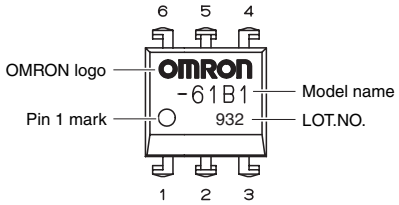
- Refer to **"Common Precautions"** for all G3VM models.

Appearance/Dimensions DIP6 type

■ Appearance

DIP (Dual Inline Package)

DIP6



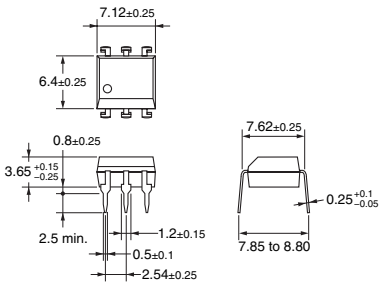
Note: The actual product is marked differently from the image shown here.

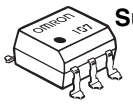
■ Dimensions

(Unit:mm)

PCB Terminals

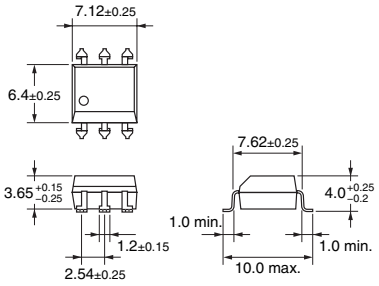
Weight: 0.4 g



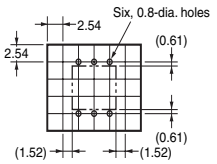


Surface-mounting Terminals

Weight: 0.4 g

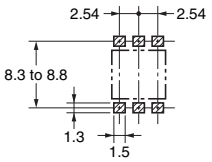


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



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OMRON Corporation
ELECTRONIC AND MECHANICAL COMPONENTS COMPANY **Contact: www.omron.com/ecb**

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